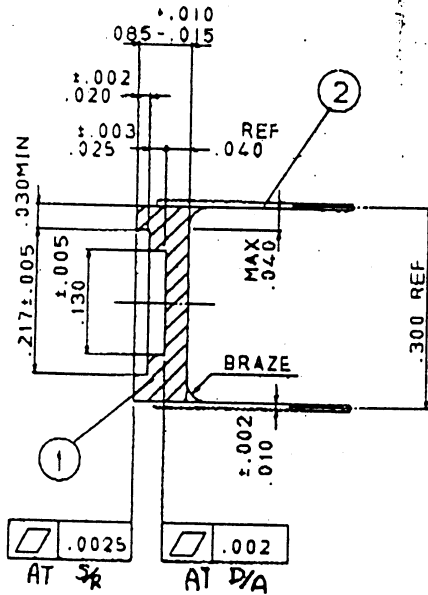
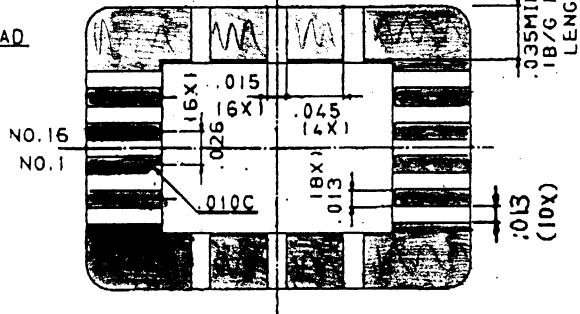


BONDING PAD



NOTES:

- (3/4, D/A PAD AND 1/4 PAD ONLY)
- 1. GOLD PLATE 60 $\mu$  INCHES MIN OVER 80 $\mu$  INCHES MIN NICKEL. LEAD UNPLATED.
- 2. NO LEAD CONNECTED TO D/A PAD.
- 3. SEAL RING ISOLATED.

TOOLED



②	LEAD	ALLOY 42	2	NEW DRAWING	JUL-3 1987
①	CERAMIC	BLACK ALUMINA	1		
Rev.	Description	Rev.	Description	Date	
1		1			
UNLESS OTHERWISE SPECIFIED. TOLERANCES: ± 1% N. L. T. 2 DECIMALS. XX ± .01 3 DECIMALS. XXX ± .005		DRAWN K. KOJIMA		NTK TECHNICAL CERAMIC NGK SPARK PLUG CO., LTD TITLE	
		CHECKED K. Fujikawa			
		APPROVED <i>[Signature]</i>			
CSB01617		UNIT INCH		DWO NO.	
		SCALE 5/1		16PIN S/B PKG	
				IDK16S1-6134AAL	
				A-	